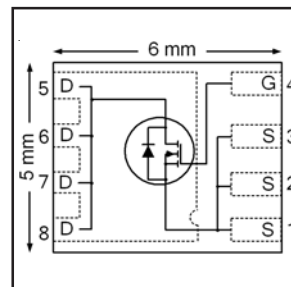


| | | |
|--|------------|-----------------------------|
| V_{DS} | 30 | V |
| $R_{DS(on) max}$ (@ $V_{GS} = 10V$) | 4.2 | mΩ |
| Q_g (typical) | 15 | nC |
| R_G (typical) | 0.6 | Ω |
| I_D (@ $T_{c(Bottom)} = 25^\circ C$) | 82 | A |



Applications

- Control MOSFET for high frequency buck converters

Features and Benefits

Features

| |
|--|
| Low charge (typical 15nC) |
| Low R_g (typical 0.6 Ω) |
| Low Thermal Resistance to PCB (<2.7 $^\circ C/W$) |
| 100% R_g tested |
| Low Profile (<0.9 mm) |
| Industry-Standard Pinout |
| Compatible with Existing Surface Mount Techniques |
| RoHS Compliant Containing no Lead, no Bromide and no Halogen |
| MSL1, Industrial Qualification |

Benefits

results in
⇒

| |
|----------------------------|
| Lower Switching Losses |
| Lower Switching Losses |
| Increased Power Density |
| Increased Reliability |
| Increased Power Density |
| Multi-Vendor Compatibility |
| Easier Manufacturing |
| Environmentally Friendlier |
| Increased Reliability |

| Orderable part number | Package Type | Standard Pack | | Note |
|-----------------------|----------------|---------------|----------|------------------|
| | | Form | Quantity | |
| IRFH5303TRPBF | PQFN 5mm x 6mm | Tape and Reel | 4000 | |
| IRFH5303TR2PBF | PQFN 5mm x 6mm | Tape and Reel | 400 | EOL notice # 259 |

Absolute Maximum Ratings

| | Parameter | Max. | Units |
|-------------------------------------|---|--------------|---------------|
| V_{DS} | Drain-to-Source Voltage | 30 | V |
| V_{GS} | Gate-to-Source Voltage | ± 20 | |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 23 | A |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 18 | |
| $I_D @ T_{c(Bottom)} = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 82 | |
| $I_D @ T_{c(Bottom)} = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 52 | |
| I_{DM} | Pulsed Drain Current ① | 330 | |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation ⑤ | 3.6 | W |
| $P_D @ T_{c(Bottom)} = 25^\circ C$ | Power Dissipation ⑤ | 46 | |
| | Linear Derating Factor ⑤ | 0.029 | W/ $^\circ C$ |
| T_J T_{STG} | Operating Junction and Storage Temperature Range | -55 to + 150 | $^\circ C$ |

Notes ① through ⑥ are on page 8

Static @ T_J = 25°C (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|-------------------------------------|---|------|------|------|-------|--|
| BV _{DSS} | Drain-to-Source Breakdown Voltage | 30 | — | — | V | V _{GS} = 0V, I _D = 250μA |
| ΔBV _{DSS} /ΔT _J | Breakdown Voltage Temp. Coefficient | — | 0.02 | — | V/°C | Reference to 25°C, I _D = 1mA |
| R _{DS(on)} | Static Drain-to-Source On-Resistance | — | 3.6 | 4.2 | mΩ | V _{GS} = 10V, I _D = 49A ③ |
| | | — | 5.7 | 6.8 | | V _{GS} = 4.5V, I _D = 49A ③ |
| V _{GS(th)} | Gate Threshold Voltage | 1.35 | 1.8 | 2.35 | V | V _{DS} = V _{GS} , I _D = 50μA |
| ΔV _{GS(th)} | Gate Threshold Voltage Coefficient | — | -6.4 | — | mV/°C | |
| I _{DSS} | Drain-to-Source Leakage Current | — | — | 5.0 | μA | V _{DS} = 24V, V _{GS} = 0V |
| | | — | — | 150 | | V _{DS} = 24V, V _{GS} = 0V, T _J = 125°C |
| I _{GSS} | Gate-to-Source Forward Leakage | — | — | 100 | nA | V _{GS} = 20V |
| | Gate-to-Source Reverse Leakage | — | — | -100 | | V _{GS} = -20V |
| g _{fs} | Forward Transconductance | 110 | — | — | S | V _{DS} = 15V, I _D = 49A |
| Q _g | Total Gate Charge | — | 41 | — | nC | V _{GS} = 10V, V _{DS} = 15V, I _D = 49A |
| Q _g | Total Gate Charge | — | 15 | 23 | nC | V _{DS} = 15V V _{GS} = 4.5V I _D = 49A See Fig.17 & 18 |
| Q _{gs1} | Pre-V _{th} Gate-to-Source Charge | — | 3.5 | — | | |
| Q _{gs2} | Post-V _{th} Gate-to-Source Charge | — | 2.5 | — | | |
| Q _{gd} | Gate-to-Drain Charge | — | 5.4 | — | | |
| Q _{godr} | Gate Charge Overdrive | — | 3.6 | — | | |
| Q _{sw} | Switch Charge (Q _{gs2} + Q _{gd}) | — | 7.9 | — | | |
| Q _{oss} | Output Charge | — | 10 | — | nC | V _{DS} = 16V, V _{GS} = 0V |
| R _G | Gate Resistance | — | 0.6 | — | Ω | |
| t _{d(on)} | Turn-On Delay Time | — | 11 | — | ns | V _{DD} = 15V, V _{GS} = 4.5V I _D = 49A R _G = 1.8Ω See Fig.15 |
| t _r | Rise Time | — | 31 | — | | |
| t _{d(off)} | Turn-Off Delay Time | — | 8.8 | — | | |
| t _f | Fall Time | — | 6.1 | — | | |
| C _{iss} | Input Capacitance | — | 2190 | — | pF | V _{GS} = 0V V _{DS} = 15V f = 1.0MHz |
| C _{oss} | Output Capacitance | — | 520 | — | | |
| C _{rss} | Reverse Transfer Capacitance | — | 220 | — | | |

Avalanche Characteristics

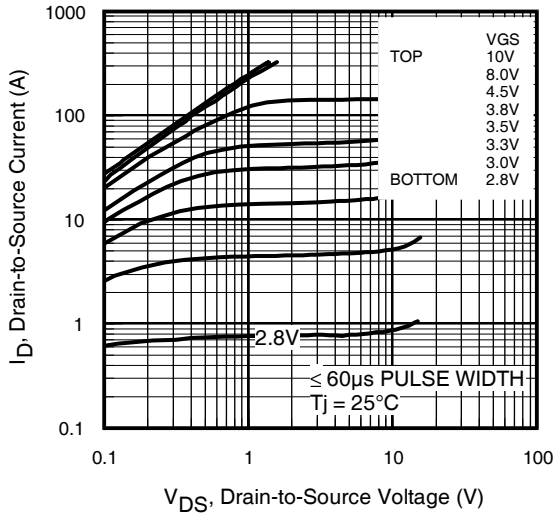
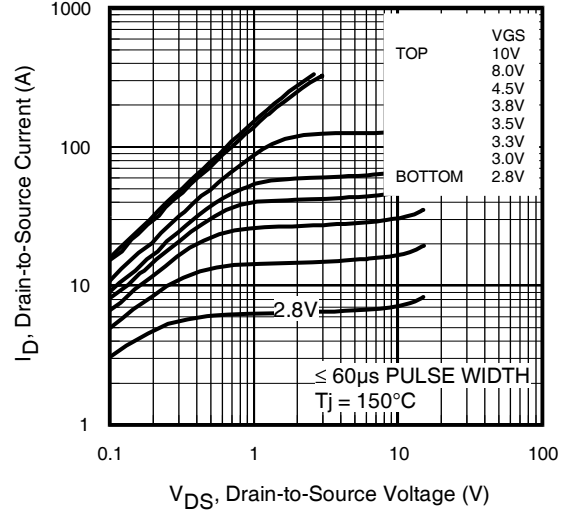
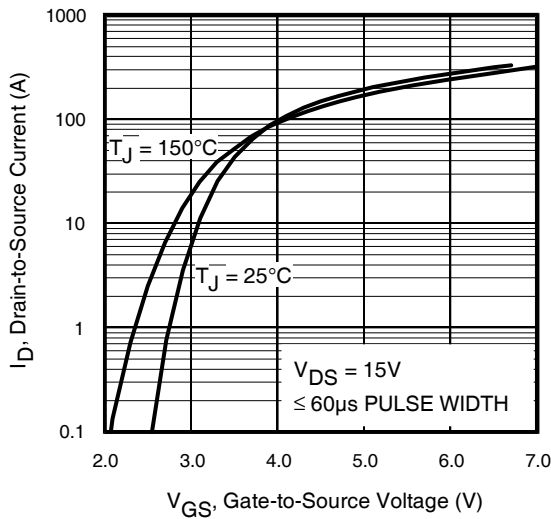
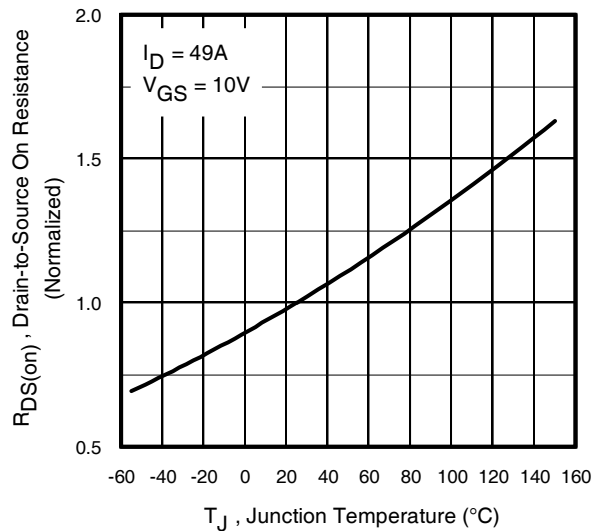
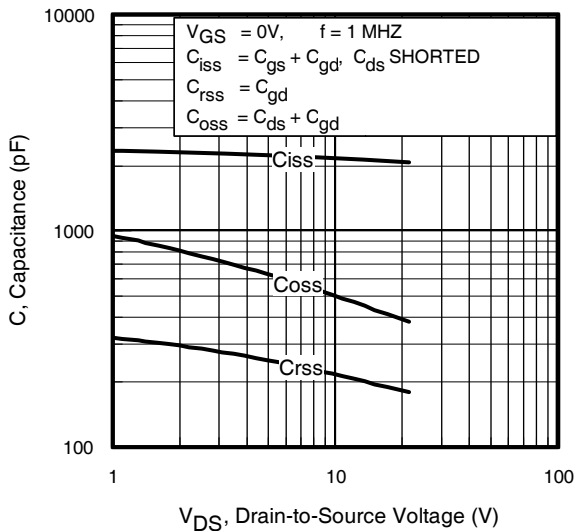
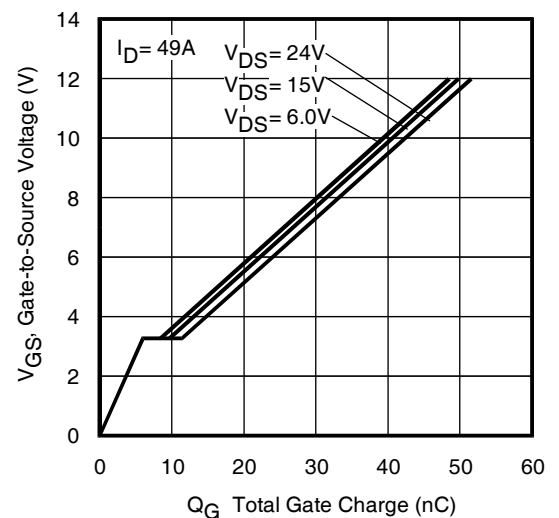
| | Parameter | Typ. | Max. | Units |
|-----------------|---------------------------------|------|------|-------|
| E _{AS} | Single Pulse Avalanche Energy ② | — | 46 | mJ |
| I _{AR} | Avalanche Current ① | — | 49 | A |

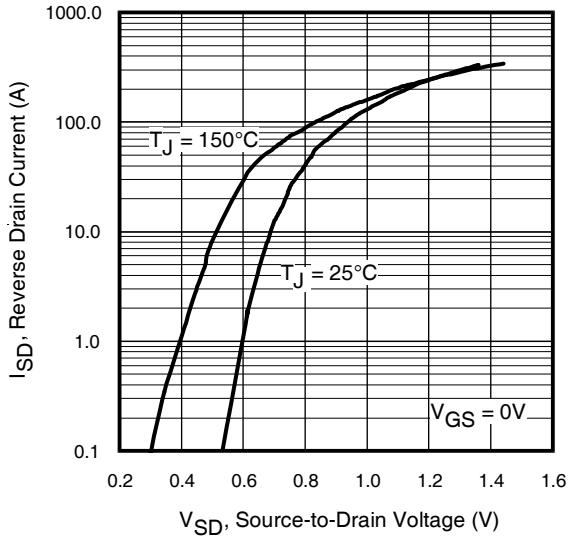
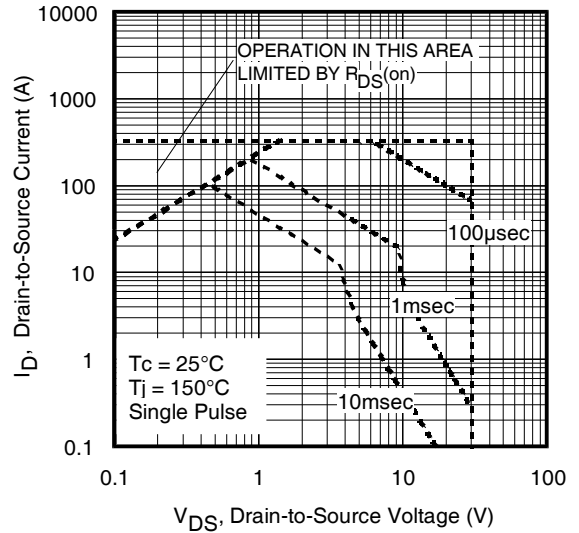
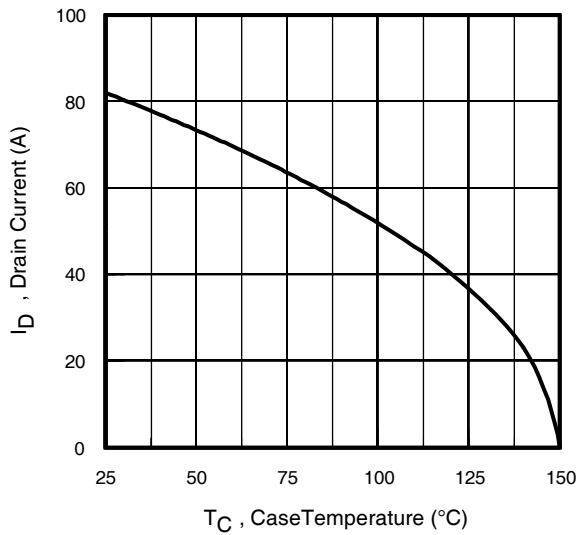
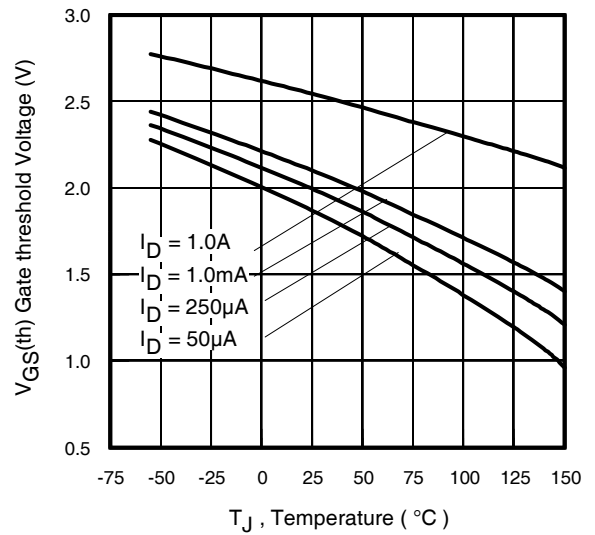
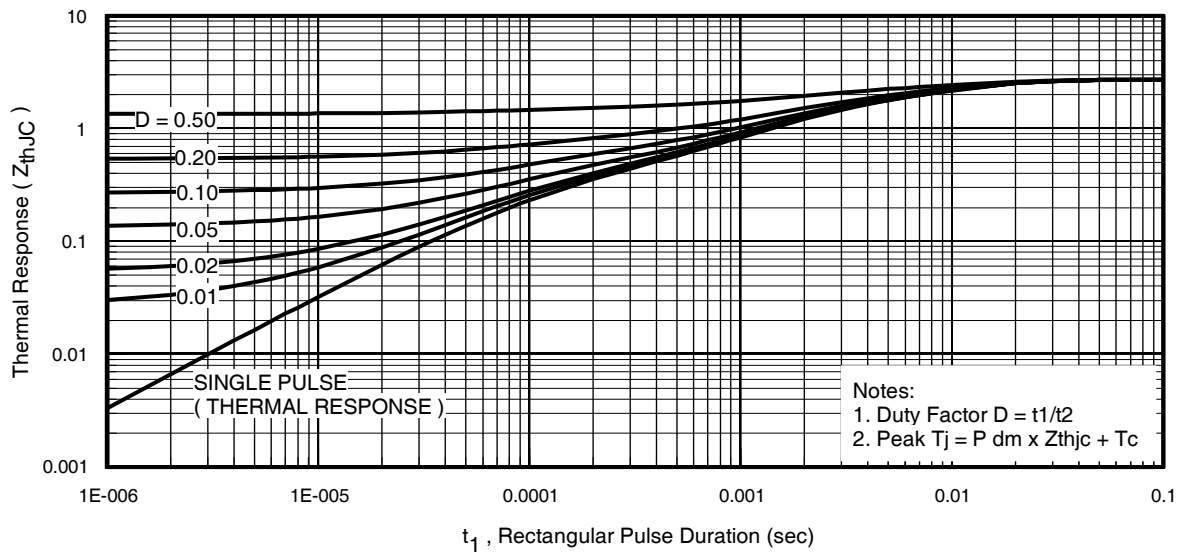
Diode Characteristics

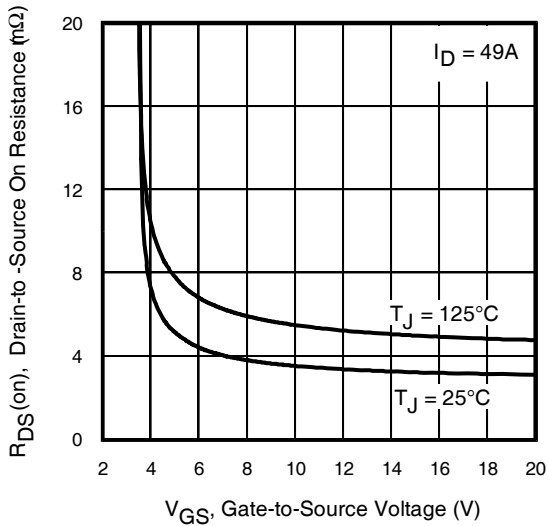
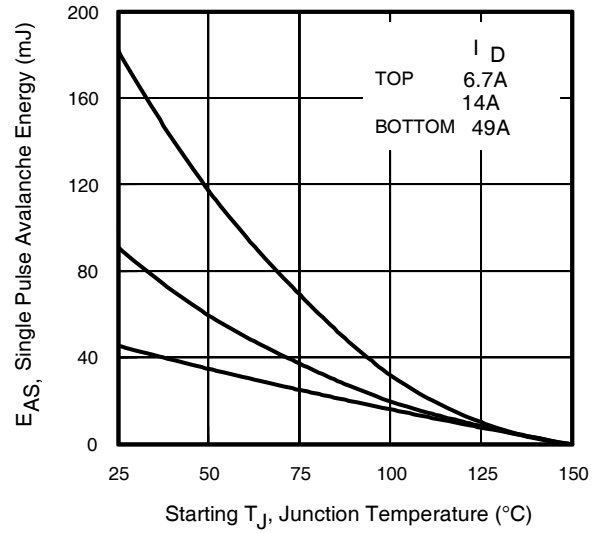
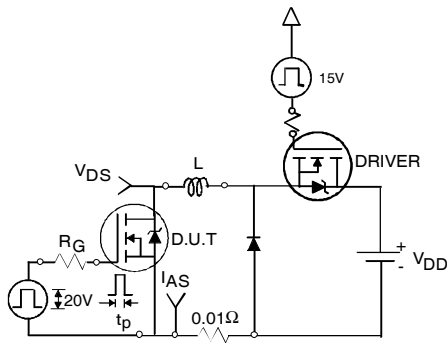
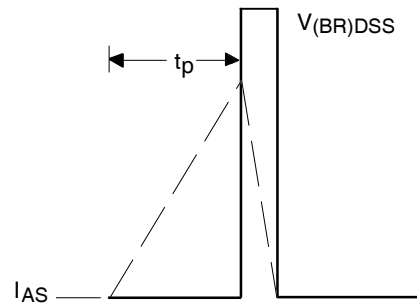
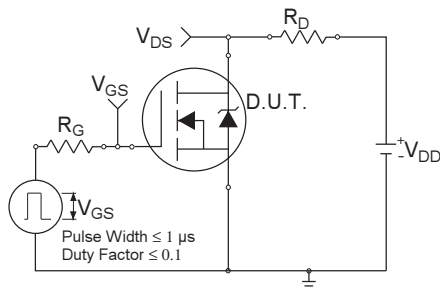
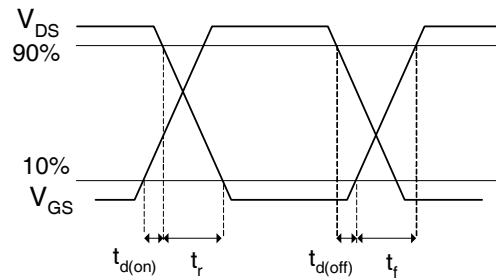
| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|-----------------|---|---|------|------|-------|---|
| I _S | Continuous Source Current (Body Diode) | — | — | 82 | A | MOSFET symbol showing the integral reverse p-n junction diode. |
| I _{SM} | Pulsed Source Current (Body Diode) ① | — | — | 330 | | |
| V _{SD} | Diode Forward Voltage | — | — | 1.0 | V | T _J = 25°C, I _S = 49A, V _{GS} = 0V ③ |
| t _{rr} | Reverse Recovery Time | — | 19 | 29 | ns | T _J = 25°C, I _F = 49A, V _{DD} = 15V |
| Q _{rr} | Reverse Recovery Charge | — | 39 | 59 | nC | di/dt = 350A/μs ③ |
| t _{on} | Forward Turn-On Time | Time is dominated by parasitic Inductance | | | | |

Thermal Resistance

| | Parameter | Typ. | Max. | Units |
|---------------------------|-----------------------|------|------|-------|
| R _{θJC} (Bottom) | Junction-to-Case ④ | — | 2.7 | °C/W |
| R _{θJC} (Top) | Junction-to-Case ④ | — | 15 | |
| R _{θJA} | Junction-to-Ambient ⑤ | — | 35 | |
| R _{θJA} (<10s) | Junction-to-Ambient ⑤ | — | 22 | |


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

Fig 9. Maximum Drain Current Vs. Case (Bottom) Temperature

Fig 10. Threshold Voltage Vs. Temperature

Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case (Bottom)


Fig 12. On-Resistance vs. Gate Voltage

Fig 13. Maximum Avalanche Energy vs. Drain Current

Fig 14a. Unclamped Inductive Test Circuit

Fig 14b. Unclamped Inductive Waveforms

Fig 15a. Switching Time Test Circuit

Fig 15b. Switching Time Waveforms

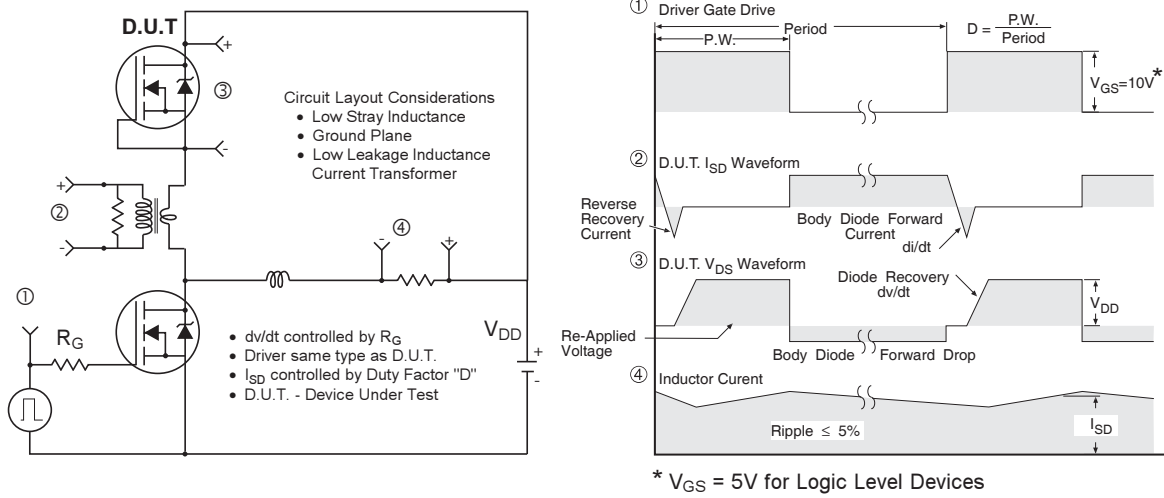


Fig 16. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

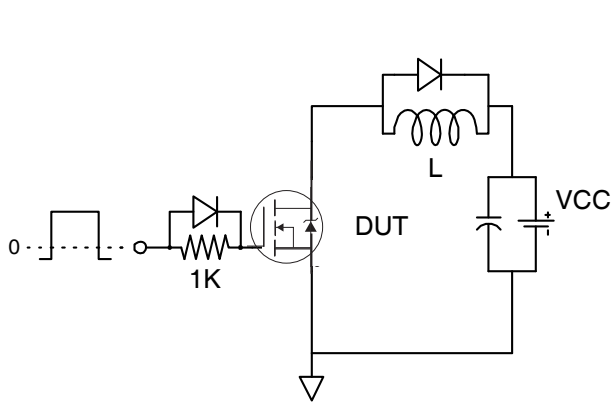


Fig 17. Gate Charge Test Circuit

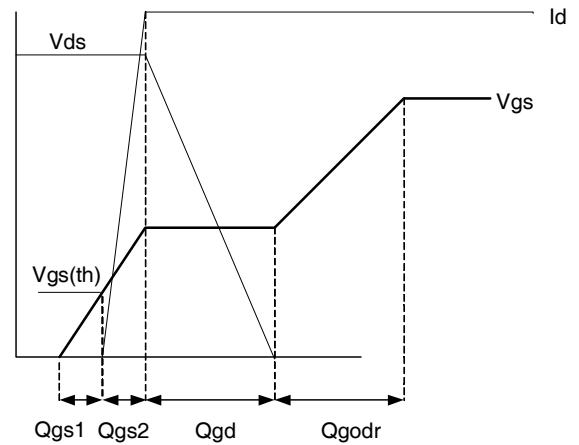
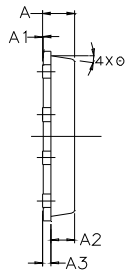
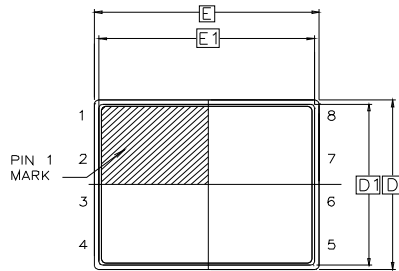


Fig 18. Gate Charge Waveform

PQFN 5x6 Outline "B" Package Details

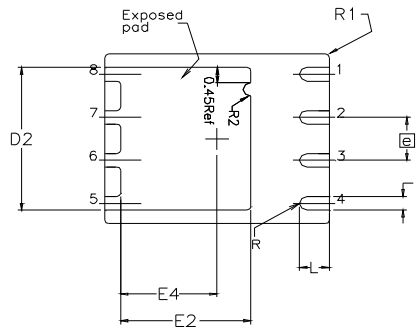


SIDE VIEW



TOP VIEW

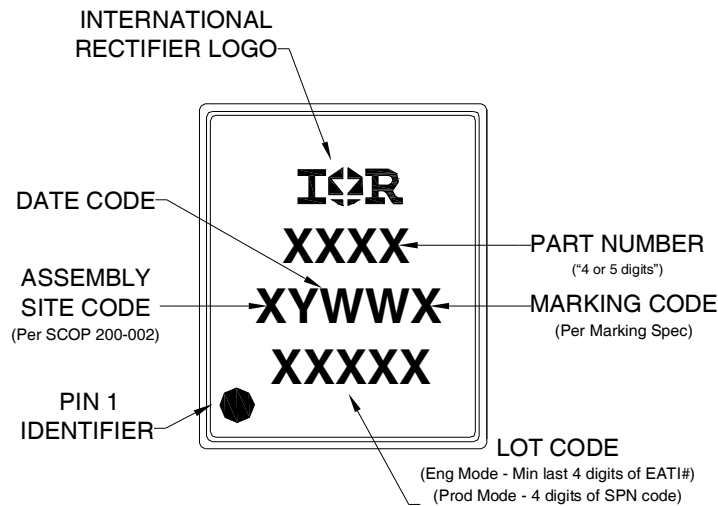
| DIM SYMBOL | MIN | NOM | MAX |
|------------|-------|-----------|-------|
| A | 0.800 | 0.830 | 1.05 |
| A1 | 0.000 | 0.020 | 0.050 |
| A2 | 0.580 | 0.630 | 0.680 |
| A3 | | 0.254 REF | |
| Ø | 0" | 10" | 12" |
| b | 0.350 | 0.400 | 0.470 |
| D | 4.850 | 5.000 | 5.150 |
| D1 | 4.675 | 4.750 | 5.000 |
| D2 | 3.700 | 4.210 | 4.300 |
| e | | 1.270 BSC | |
| E | 5.850 | 6.000 | 6.150 |
| E1 | 5.675 | 5.750 | 6.000 |
| E2 | 3.380 | 3.480 | 3.760 |
| E4 | 2.480 | 2.580 | 2.680 |
| L | 0.550 | 0.800 | 0.900 |
| R | | 0.200 REF | |
| R1 | | 0.100 REF | |
| R2 | 0.150 | 0.200 | 0.250 |



BOTTOM VIEW

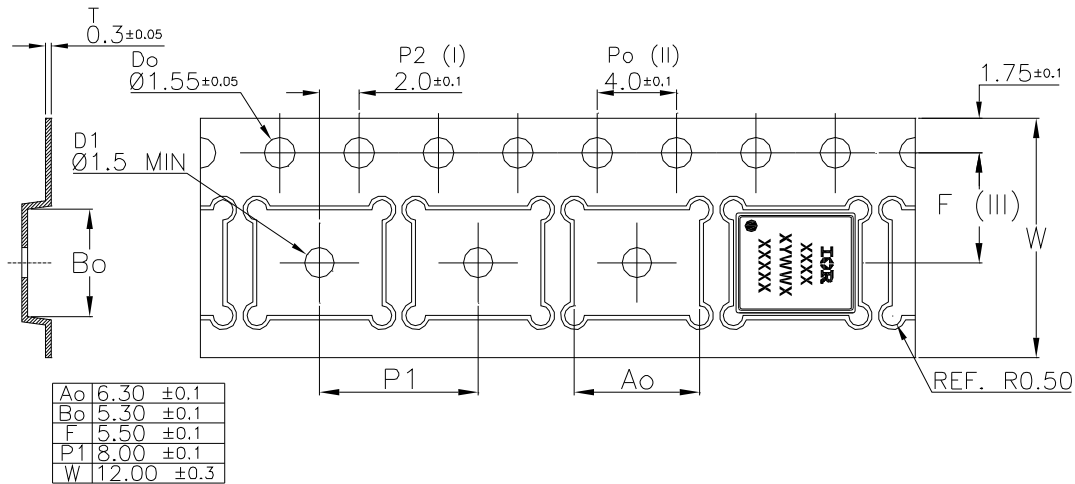
For footprint and stencil design recommendations, please refer to application note AN-1154 at <http://www.irf.com/technical-info/appnotes/an-1154.pdf>

PQFN 5x6 Outline "B" Part Marking



Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

PQFN Tape and Reel



Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

Qualification information[†]

| | | |
|----------------------------|---|--|
| Qualification level | Industriid ^{††} (per JEDEC JESD47F ^{†††} guidelines) | |
| Moisture Sensitivity Level | PQFN 5mm x 6mm | MSL1 (per JEDEC J-STD-020D ^{†††}) |
| RoHS compliant | Yes | |

† Qualification standards can be found at International Rectifier’s web site

<http://www.irf.com/product-info/reliability>

†† Higher qualification ratings may be available should the user have such requirements.

Please contact your International Rectifier sales representative for further information:

<http://www.irf.com/whoto-call/salesrep/>

††† Applicable version of JEDEC standard at the time of product release.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting T_J = 25°C, L = 0.038mH, R_G = 25Ω, I_{AS} = 49A.
- ③ Pulse width ≤ 400μs; duty cycle ≤ 2%.
- ④ R_θ is measured at T_J of approximately 90°C.
- ⑤ When mounted on 1 inch square 2 oz copper pad on 1.5x1.5 in. board of FR-4 material.

Revision History

| Date | Comment |
|-----------|--|
| 5/13/2014 | <ul style="list-style-type: none"> • Updated ordering information to reflect the End-Of-life (EOL) of the mini-reel option (EOL notice #259) • Updated package outline on page 7. • Updated data sheet based on corporate template. |